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Precision Thin Film Chip Resistors



Automotive-grade MC AT precision thin film chip resistors are the perfect choice for most fields of modern precision electronics where reliability and stability is of major concern. Typical applications include automotive, telecommunication, industrial, medical equipment, precision test, and measuring equipment.

FEATURES

- Rated dissipation P₇₀ up to 0.4 W for size 1206
- AEC-Q200 qualified
- Approved to EN 140401-801
- · Superior temperature cycling robustness
- Sulfur resistance verified according to ASTM B 809
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>



RoHS

APPLICATIONS

- Automotive
- Telecommunication
- · Industrial equipment
- Medical equipment

TECHNICAL SPECIFICATIONS						
DESCRIPTION	MCS 0402 AT	MCT 0603 AT	MCU 0805 AT	MCA 1206 AT		
Imperial size	0402	0402 0603		1206		
Metric size code	RR1005M	RR1608M	RR2012M	RR3216M		
Resistance range	47 Ω to 221 kΩ	47 Ω to 511 kΩ	47 Ω to 1 M Ω	47 Ω to 1 M Ω		
Resistance tolerance	Resistance tolerance ± 0.1 %					
Temperature coefficient	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K					
Rated dissipation P ₇₀ ⁽¹⁾	0.100 W	0.125 W	0.200 W	0.400 W		
Operating voltage, U _{max.} AC _{RMS} or DC	50 V	75 V	150 V	200 V		
Permissible film temperature, $g_{\text{F max.}}^{(1)}$	155 °C					
Operating temperature range		-55 °C to	o 155 °C			
Insulation voltage:						
1 min; U _{ins}	75 V	100 V	200 V	300 V		
Continuous	75 V	75 V	75 V	75 V		
Failure rate: FIT _{observed}	e rate: FIT _{observed} ≤ 0.1 x 10 ⁻⁹ /h					

Note

(1) Please refer to APPLICATION INFORMATION below.

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APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

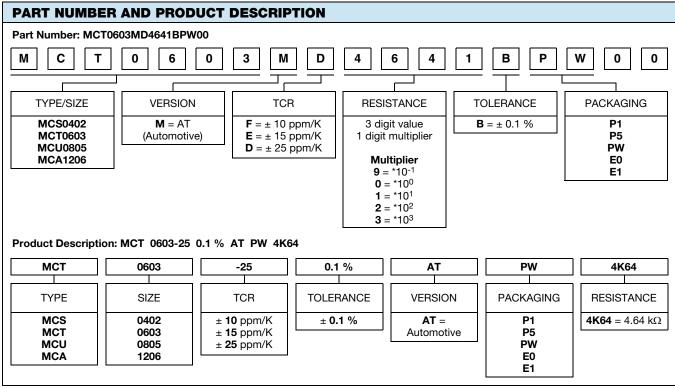
MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION							
OPERATION MODE		STANDARD	POWER				
	MCS 0402 AT	0.063 W	0.100 W				
Data d dissipation D	MCT 0603 AT	0.100 W	0.125 W				
Rated dissipation, P ₇₀	MCU 0805 AT	0.125 W	0.200 W				
	MCA 1206 AT	0.250 W	0.400 W				
Operating temperature range		-55 °C to 125 °C	-55 °C to 155 °C				
Permissible film temperature, $g_{\rm Fmax}$	Permissible film temperature, $\vartheta_{\text{F max.}}$		155 °C				
	MCS 0402 AT	47 Ω to 221 k Ω	47 Ω to 221 kΩ				
	MCT 0603 AT	47 Ω to 511 k Ω	47 Ω to 511 kΩ				
	MCU 0805 AT	47 Ω to 1 M Ω	47 Ω to 1 M Ω				
Max. resistance change at P_{70}	MCA 1206 AT	47 Ω to 1 M Ω	47 Ω to 1 M Ω				
for resistance range, $\Delta R/R$ after:							
	1000 h	≤ 0.1 %	≤ 0.2 %				
	8000 h	≤ 0.2 %	≤ 0.4 %				
	225 000 h	≤ 0.6 %	-				

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE							
TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES			
	± 25 ppm/K		47 Ω to 221 k Ω				
MCS 0402 AT	± 15 ppm/K	± 0.1 %	47 Ω to 100 k Ω	E24; E192			
	± 10 ppm/K		47 Ω to 10 k Ω				
	± 25 ppm/K		47 Ω to 511 kΩ				
MCT 0603 AT	± 15 ppm/K	± 0.1 %	47 Ω to 221 k Ω	E24; E192			
	± 10 ppm/K		47 Ω to 22.1 kΩ				
	± 25 ppm/K		47 Ω to 1 M Ω				
MCU 0805 AT	± 15 ppm/K	± 0.1 %	47 Ω to 332 kΩ	E24; E192			
	± 10 ppm/K		47 Ω to 33.2 k Ω				
	± 25 ppm/K		47 Ω to 1 MΩ				
MCA 1206 AT	± 15 ppm/K	± 0.1 %	47 Ω to 511 kΩ	E24; E192			
	± 10 ppm/K		47 Ω to 43.2 k Ω				

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PACKAGING									
TYPE / SIZE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER			
MCS 0402 AT	E1	1000		8 mm	0	180 mm/7"			
WC3 0402 A1	E0	10 000		0 111111	2 mm				
	P1	1000		8 mm	4 mm	180 mm/7"			
MCT 0603 AT	P5	5000				180 11111/7			
	PW	20 000	Paper tape acc. IEC 60286-3			330 mm/13"			
	P1	1000	type 1a		4 mm	100/7!			
MCU 0805 AT	P5	5000				180 mm/7"			
	PW	20 000				330 mm/13"			
MCA 1206 AT	P1	1000]	8 mm	4	100 /7!!			
	P5	5000			4 mm	180 mm/7"			



Note

• Products can be ordered using either the PART NUMBER or PRODUCT DESCRIPTION.

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DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of special metal alloy is deposited on a high grade ceramic substrate (Al_2O_3) and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly cutting a meander groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a unique protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure matte tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. This includes full screening for the elimination of products with potential risk of early field failures (feasible for $R \ge 10~\Omega$). Only accepted products are laid directly into the paper tape in accordance with **IEC 60286-3 Type 1a** (1).

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant; the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the **IEC 62474**, Material Declaration for Products of and for the Electrotechnical Industry.

The dedicated database ⁽²⁾, that lists declarable substances, ensures full compliance with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

APPROVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-801** which refers to **EN 60115-1**, **EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** (1) series. The detail specification refers to the climatic categories 55/125/56, which relates to the "standard operation mode" of this datasheet.

Conformity is attested by the use of the **CECC** logo (\clubsuit) as the mark of conformity on the package label. For extended resistance ranges (> 100 k Ω , > 47 Ω for 0402) and TCR \pm 10 ppm/K the certification according to DIN EN 140401-801:2008-05 is pending.

Vishay Beyschlag has achieved "Approval of Manufacturer" in accordance with IECQ 03-1. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IECQ 03-3-1 is granted for the Vishay Beyschlag manufacturing process.

The resistors are qualified according to AEC-Q200.

RELATED PRODUCTS

For more information about products with higher operation temperature please refer to the **professional** datasheet (www.vishav.com/doc?28760).

Chip resistor arrays may be used in sensing applications or precision amplifiers where close matching between multiple resistors is necessary. Please refer to the ACAS AT - Precision datasheet (www.vishay.com/doc?28770).

MC AT Precision is also available with gold termination for conductive gluing. Please refer to the datasheet (www.vishay.com/doc?28877).

For high power and high temperature applications MCW 0406 AT wide terminal thin film chip resistors offer extremely high power ratings in compact 0406 case size and extraordinary temperature cycling robustness.

Please refer to the datasheets for

precision (www.vishay.com/doc?28847) and professional (www.vishay.com/doc?28796) specification.

Notes

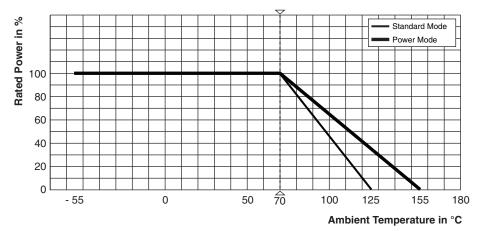
(1) The quoted IEC standards are also released as EN standards with the same number and identical contents.

(2) IEC 62474 database can be found at: http://std.iec.ch/iec62474.

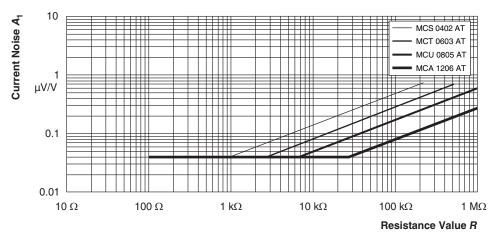
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FUNCTIONAL PERFORMANCE



For permissible resistance change please refer to table MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION, above **Derating**



Current noise A₁ in accordance with IEC 60195

Current Noise

TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8 (successor of EN 140400), sectional specification

EN 140401-801, detail specification

IEC 60068-2-xx, test methods

The components are approved under the IECQ-CECC quality assessment system for electronic components.

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/ECA-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C
Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on printed circuit boards in accordance with EN 60115-8, 2.4.2, unless otherwise specified.



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EN 60115-1	IEC 60068-2 (1) TEST	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△R)
CLAUSE	METHOD	. 20.		STABILITY CLASS 0.25 OR BETTER (2
	1		Stability for product types:	
			MCS 0402 AT	47 Ω to 221 kΩ
			MCT 0603 AT	47 Ω to 511 kΩ
			MCU 0805 AT	47 Ω to 1 MΩ
			MCA 1206 AT	47 Ω to 1 MΩ
4.5	-	Resistance		± 0.1 % R
4.8.4.2	-	Temperature coefficient	At (20 / -55 / 20) °C and (20 / 155 / 20) °C	± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K
4.25.1		Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	± (0.1 % R + 0.02 Ω) ± (0.2 % R + 0.02 Ω)
4.20.1		Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$; whichever is the less severe; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	± (0.2 % R + 0.02 Ω) ± (0.4 % R + 0.05 Ω)
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h 155 °C; 1000 h	± (0.15 % R + 0.02 Ω) ± (0.3 % R + 0.02 Ω)
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.1 % R + 0.02 Ω)
4.37	67 (Cy)	Damp heat, steady state, accelerated Standard operation mode	(85 ± 2) °C (85 ± 5) % RH $U = \sqrt{0.1 \times P_{70} \times R}$; $U \le 0.3 \times U_{\text{max}}$; 1000 h	± (0.5 % R + 0.05 Ω)
4.23		Climatic sequence: Standard operation mode		
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h	
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 1 cycle	
4.23.4	1 (Aa)	Cold	-55 °C; 2 h	± (0.25 % R + 0.02 Ω)
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C	
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 5 cycles	
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}; 1 \text{ min}$	
-	1 (Aa)	Storage at low temperature	-55 °C; 2 h	± (0.05 % R + 0.01 Ω)
		Rapid change of temperature	30 min at -55 °C and 30 min at 155 °C; 1000 cycles	± (0.25 % R + 0.02 Ω)
4.19	14 (Na)	Extended rapid change of temperature	30 min at -40 °C; 30 min at 125 °C ⁽³⁾ ; MCS 0402 AT: 3000 cycles MCT 0603 AT: 2000 cycles MCU 0805 AT: 1500 cycles MCA 1206 AT: 1000 cycles	\pm (0.25 % R + 0.05 Ω); (≥ 50 % of initial shear force)
4.13	-	Short time overload: Standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{\text{max.}}$; whichever is the less severe; 5 s	± (0.05 % R + 0.01 Ω)



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TEST PR	OCEDURES	AND REQUIREMENTS		
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)
	METHOD			STABILITY CLASS 0.25 OR BETTER (2)
		Stability for product types:		
		MCS 0402 AT	47 Ω to 221 kΩ	
			MCT 0603 AT	47 Ω to 511 kΩ
			MCU 0805 AT	47 Ω to 1 MΩ
			MCA 1206 AT	47 Ω to 1 MΩ
4.27	-	Single pulse high voltage overload: Standard operation mode	Severity no. 4: $U=10 \text{ x } \sqrt{P_{70} \text{ x R}}$ or $U=2 \text{ x } U_{\text{max.}};$ whichever is the less severe; 10 pulses 10 µs/700 µs	± (0.25 % R + 0.05 Ω)
4.39	-	Periodic electric overload: Standard operation mode	$U = \sqrt{15 \times P_{70} \times R} \text{or}$ $U = 2 \times U_{\text{max.}}$ whichever is the less severe; $0.1 \text{ s on; } 2.5 \text{ s off;}$ 1000 cycles	± (0.5 % R + 0.05 Ω)
4.40	-	Electro Static Discharge (Human Body Model)	IEC 61340-3-1 (1); 3 pos. + 3 neg. (equivalent to MIL-STD-883, method 3015) MCS 0402 AT: 500 V MCT 0603 AT: 1000 V MCU 0805 AT: 1500 V MCA 1206 AT: 2000 V	± (0.5 % R + 0.05 Ω)
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s²; 7.5 h	± (0.05 % R + 0.01 Ω) no visible damage
			Solder bath method; SnPb40; non-activated flux (215 ± 3) °C; (3 ± 0.3) s	Good tinning (≥ 95 % covered); no visible damage
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.05 % R + 0.01 Ω)
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol +50 °C; method 2	No visible damage
	04 (11.)	01	RR1005M and RR1608M; 9 N	No. 1200
4.32	21 (Ue ₃)	Shear (adhesion)	RR2012M and RR3216M; 45 N	No visible damage
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	\pm (0.05 % R + 0.01 Ω) no visible damage; no open circuit in bent position
4.7	-	Voltage proof	$U_{RMS} = U_{ins}; (60 \pm 5) s$	No flashover or breakdown
4.35	-	Flammability	Needle flame test; 10 s	No burning after 30 s

Notes

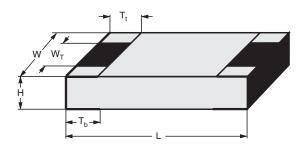
⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents.

⁽²⁾ According to the detail specification EN 140401-801 the stability class applies to the category temperatures 85 °C and 125 °C and their respective test conditions.

⁽³⁾ Tested on a 4-layer printed circuit board with SAC micro alloy.

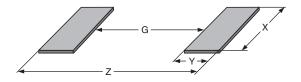
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DIMENSIONS



DIMENSIONS AND MASS									
TYPE / SIZE	H (mm)	L (mm)	W (mm)	W _T (mm)	T _t (mm)	T _b (mm)	MASS (mg)		
MCS 0402 AT	0.32 ± 0.05	1.0 ± 0.05	0.5 ± 0.05	> 75 % of W	0.2 + 0.1/- 0.15	0.2 ± 0.1	0.6		
MCT 0603 AT	0.45 + 0.1/- 0.05	1.55 ± 0.05	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9		
MCU 0805 AT	0.52 ± 0.1	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 + 0.1/- 0.2	0.4 + 0.1/- 0.2	4.6		
MCA 1206 AT	0.55 ± 0.1	3.2 + 0.1/- 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2		

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS									
TYPE / SIZE		WAVE SO	LDERING		REFLOW SOLDERING				
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)	
MCS 0402 AT	-	-	-	-	0.35	0.55	0.55	1.45	
MCT 0603 AT	0.55	1.10	1.10	2.75	0.65	0.70	0.95	2.05	
MCU 0805 AT	0.80	1.25	1.50	3.30	0.90	0.90	1.40	2.70	
MCA 1206 AT	1.40	1.50	1.90	4.40	1.50	1.15	1.75	3.80	

Note

• The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly. Specified power rating above 125 °C requires dedicated heat-sink pads, which to a great extend depend on board materials. The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode". Please note however that applications for "power operation mode" require special considerations for the design of solder pads and adjacent conductor areas.



Legal Disclaimer Notice

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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